



N-Channel 30-V (D-S) 175°C MOSFET

CHARACTERISTICS

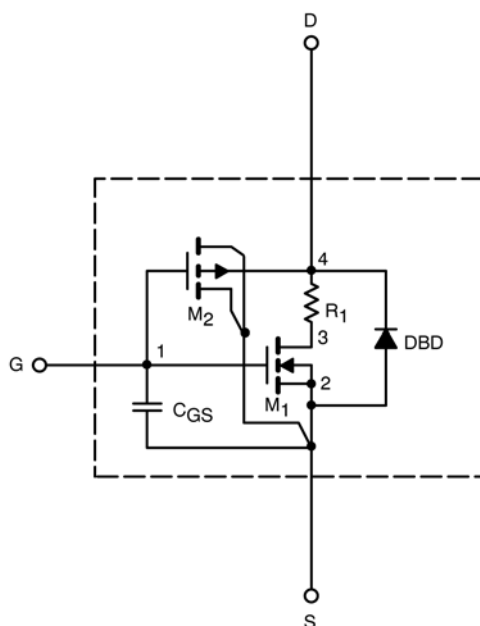
- N-Channel Vertical DMOS
- Macro Model (Subcircuit Model)
- Level 3 MOS
- Apply for both Linear and Switching Application
- Accurate over the -55 to 125°C Temperature Range
- Model the Gate Charge, Transient, and Diode Reverse Recovery Characteristics

DESCRIPTION

The attached spice model describes the typical electrical characteristics of the n-channel vertical DMOS. The subcircuit model is extracted and optimized over the -55 to 125°C temperature ranges under the pulsed 0-V to 10-V gate drive. The saturated output impedance is best fit at the gate bias near the threshold voltage.

A novel gate-to-drain feedback capacitance network is used to model the gate charge characteristics while avoiding convergence difficulties of the switched C_{gd} model. All model parameter values are optimized to provide a best fit to the measured electrical data and are not intended as an exact physical interpretation of the device.

SUBCIRCUIT MODEL SCHEMATIC



SPICE Device Model SUP/SUB85N03-04P

Vishay Siliconix



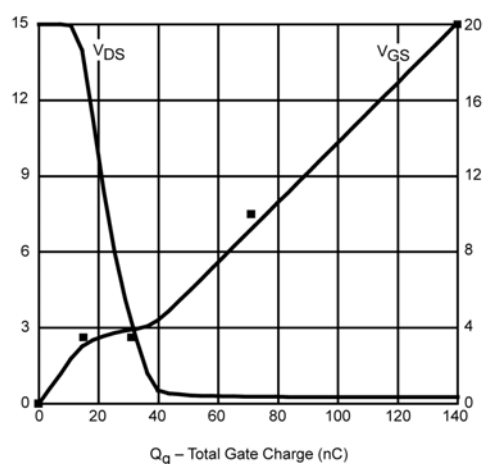
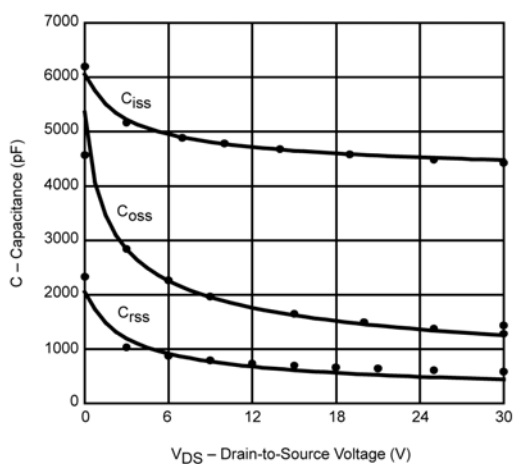
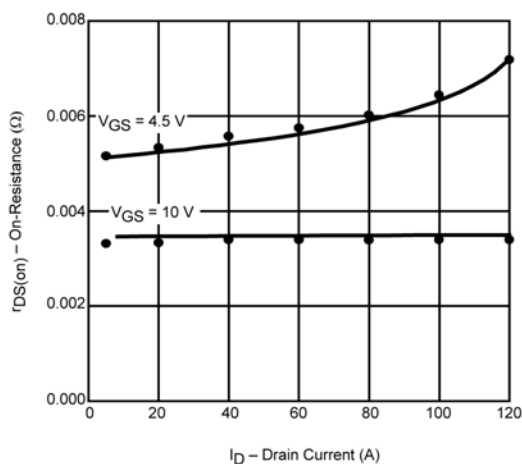
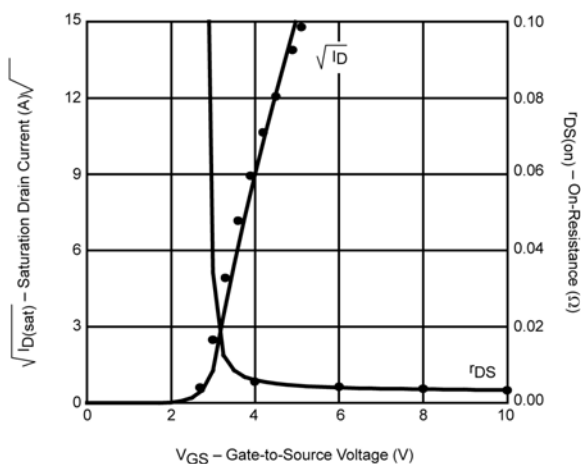
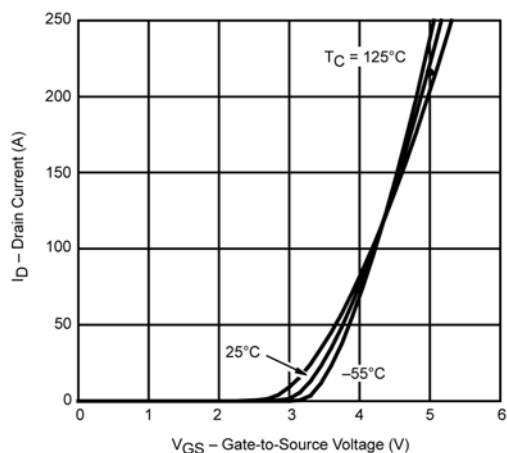
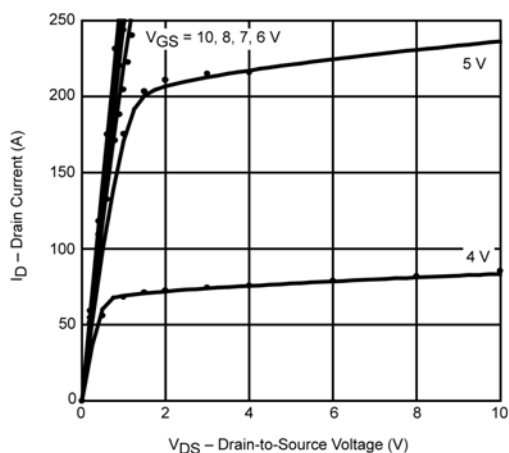
SPECIFICATIONS (T _J = 25°C UNLESS OTHERWISE NOTED)					
Parameter	Symbol	Test Condition	Simulated Data	Measured Data	Unit
Static					
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250 μA	2.1		V
On-State Drain Current ^a	I _{D(on)}	V _{DS} = 5 V, V _{GS} = 10 V	1234		A
Drain-Source On-State Resistance ^a	r _{DS(on)}	V _{GS} = 10 V, I _D = 30 A	0.0035	0.0035	Ω
		V _{GS} = 4.5 V, I _D = 20 A	0.0052	0.0055	
		V _{GS} = 10 V, I _D = 30 A, T _J = 125°C	0.0050		
		V _{GS} = 10 V, I _D = 30 A, T _J = 175°C	0.0059		
Forward Transconductance ^a	g _{fs}	V _{DS} = 15 V, I _D = 30 A	88		S
Forward Voltage ^a	V _{SD}	I _S = 85 A, V _{GS} = 0 V	0.92	1.1	V
Dynamic^b					
Input Capacitance	C _{iss}	V _{GS} = 0 V, V _{DS} = 25 V, f = 1 MHz	4524	4500	pF
Output Capacitance	C _{oss}		1351	1380	
Reverse Transfer Capacitance	C _{rss}		488	615	
Total Gate Charge ^c	Q _g	V _{DS} = 15 V, V _{GS} = 10 V, I _D = 85 A	76	71	nC
Gate-Source Charge ^c	Q _{gs}		15	15	
Gate-Drain Charge ^c	Q _{gd}		16	16	
Turn-On Delay Time ^c	t _{d(on)}	V _{DD} = 15 V, R _L = 0.18 Ω I _D = 85 A, V _{GEN} = 10 V, R _G = 2.5 Ω	17	15	ns
Rise Time ^c	t _r		25	12	
Turn-Off Delay Time ^c	t _{d(off)}		34	50	
Fall Time ^c	t _f		48	22	
Reverse Recovery Time	t _{rr}	I _F = 85 A, di/dt = 100 A/μs	45	42	

Notes

- Pulse test; pulse width ≤ 300 μs, duty cycle ≤ 2%.
- Guaranteed by design, not subject to production testing.
- Independent of operating temperature.



COMPARISON OF MODEL WITH MEASURED DATA ($T_J=25^\circ\text{C}$ UNLESS OTHERWISE NOTED)



Note: Dots and squares represent measured data.



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